

Product / Process Change Notification



N° PCN 2016-090-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of an additional wafer fab and wafer test location in Dresden, Germany affecting SFET4 40V in TOLL packages

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **30. November 2017**.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
Postal Address Headquarters: Am Campeon 1-12, D-85579 Neubiberg, Phone +49 (0)89 234-0
Chairman of the Supervisory Board: Wolfgang Mayrhuber
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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► Products affected:	Sales Name	SP N°	OPN	Package
	IPLU250N04S4-1R7	SP001121552	IPLU250N04S41R7XTMA1	PG-HSOF-8
	IPLU300N04S4-1R1	SP001121554	IPLU300N04S41R1XTMA1	PG-HSOF-8
	IPLU300N04S4-R8	SP001063102	IPLU300N04S4R8XTMA1	PG-HSOF-8

► Detailed Change Information:

Subject: Introduction of an additional wafer fab and wafer test location in Dresden, Germany affecting SFET4 40V in TOLL packages.

Reason: Flexibility of Frontend Production and secure supply.

Description:	<u>Old</u>	<u>New</u>
Wafer fab location:	■ Infineon Technologies Austria AG, Villach, Austria	■ Infineon Technologies Austria AG, Villach, Austria <i>and</i> ■ Infineon Technologies Dresden, Germany
Wafer diameter:	■ 200mm	■ 200mm <i>and</i> ■ 300mm
Wafer test location:	■ Infineon Technologies Austria AG, Villach, Austria	■ Infineon Technologies Austria AG, Villach, Austria <i>and</i> ■ Infineon Technologies Dresden, Germany

► **Product Identification:** Traceability ensured by lot number.

► **Impact of Change:** No change in form fit or function and no impact on quality and reliability of the final product.
The wafer test location verification is performed via the Advanced Measurement System Analysis (AMSA) methodology.

► **Attachments:** N.a.

► Time Schedule:

- | | |
|-------------------------------|----------------------|
| ■ Final qualification report: | Available on request |
| ■ First samples available: | Available |
| ■ Intended start of delivery: | April 2018 |

If you have any questions, please do not hesitate to contact your local Sales office.